



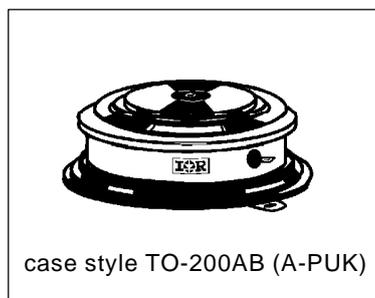
DISCRETE POWER DIODES and THYRISTORS
DATA BOOK

INVERTER GRADE THYRISTORS
Hockey Puk Version
Features

- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high dI/dt
- High surge current capability
- Low thermal impedance
- High speed performance

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

330A


case style TO-200AB (A-PUK)

Major Ratings and Characteristics

| Parameters | ST173C..C | Units |
|-------------------|----------------|-------------------|
| $I_{T(AV)}$ | 330 | A |
| @ T_{hs} | 55 | °C |
| $I_{T(RMS)}$ | 610 | A |
| @ T_{hs} | 25 | °C |
| I_{TSM} | @ 50Hz 4680 | A |
| | @ 60Hz 4900 | A |
| I^2t | @ 50Hz 110 | KA ² s |
| | @ 60Hz 100 | KA ² s |
| V_{DRM}/V_{RRM} | 1000 to 1200 | V |
| t_q range | 15 to 30 | μs |
| T_J | - 40 to 125 | °C |

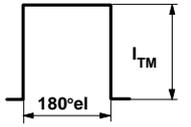
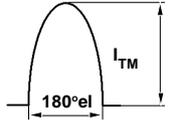
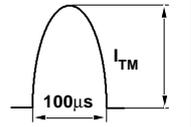
ST173C..C Series

ELECTRICAL SPECIFICATIONS

Voltage Ratings

| Type number | Voltage Code | V_{DRM}/V_{RRM} , maximum repetitive peak voltage V | V_{RSM} , maximum non-repetitive peak voltage V | I_{DRM}/I_{RRM} max. @ $T_J = T_{J \text{ max.}}$ mA |
|-------------|--------------|--|--|--|
| ST173C..C | 10 | 1000 | 1100 | 40 |
| | 12 | 1200 | 1300 | |

Current Carrying Capability

| Frequency |  | |  | |  | | Units |
|----------------------------------|---|-----|--|------|---|------|-------|
| | 760 | 660 | 1200 | 1030 | 5570 | 4920 | |
| 50Hz | 760 | 660 | 1200 | 1030 | 5570 | 4920 | A |
| 400Hz | 730 | 590 | 1260 | 1080 | 2800 | 2460 | |
| 1000Hz | 600 | 490 | 1200 | 1030 | 1620 | 1390 | |
| 2500Hz | 350 | 270 | 850 | 720 | 800 | 680 | |
| Recovery voltage Vr | 50 | 50 | 50 | 50 | 50 | 50 | V |
| Voltage before turn-on Vd | V_{DRM} | | V_{DRM} | | V_{DRM} | | |
| Rise of on-state current di/dt | 50 | 50 | - | - | - | - | A/µs |
| Heatsink temperature | 40 | 55 | 40 | 55 | 40 | 55 | °C |
| Equivalent values for RC circuit | 47Ω / 0.22µF | | 47Ω / 0.22µF | | 47Ω / 0.22µF | | |

On-state Conduction

| Parameter | ST173C..C | Units | Conditions | | |
|---|-----------|-----------|---|----------------|---|
| $I_{T(AV)}$ Max. average on-state current @ Heatsink temperature | 330 (120) | A | 180° conduction, half sine wave | | |
| | 55 (85) | °C | double side (single side) cooled | | |
| $I_{T(RMS)}$ Max. RMS on-state current | 610 | A | DC @ 25°C heatsink temperature double side cooled | | |
| I_{TSM} Max. peak, one half cycle, non-repetitive surge current | 4680 | | t = 10ms | No voltage | Sinusoidal half wave, Initial $T_J = T_{J \text{ max}}$ |
| | 4900 | | t = 8.3ms | reapplied | |
| | 3940 | | t = 10ms | 100% V_{RRM} | |
| | 4120 | t = 8.3ms | reapplied | | |
| I^2t Maximum I^2t for fusing | 110 | KA²s | t = 10ms | No voltage | |
| | 100 | | t = 8.3ms | reapplied | |
| | 77 | | t = 10ms | 100% V_{RRM} | |
| | 71 | | t = 8.3ms | reapplied | |
| $I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing | 1100 | KA²√s | t = 0.1 to 10ms, no voltage reapplied | | |

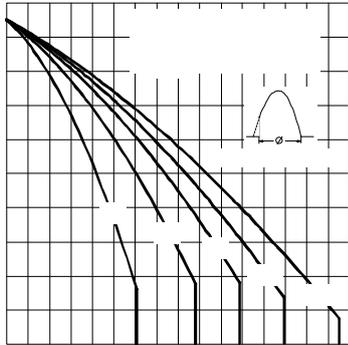


Fig. 3 - Current Ratings Characteristics

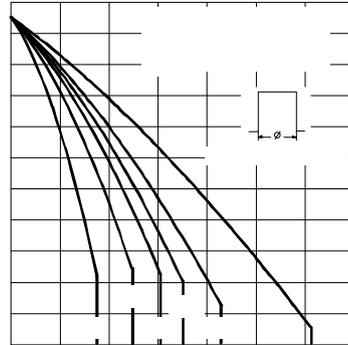


Fig. 4 - Current Ratings Characteristics

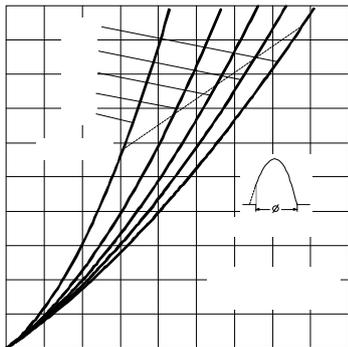


Fig. 5 - On-state Power Loss Characteristics

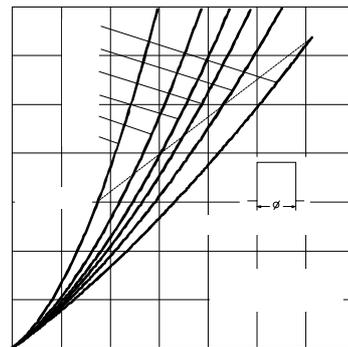


Fig. 6 - On-state Power Loss Characteristics

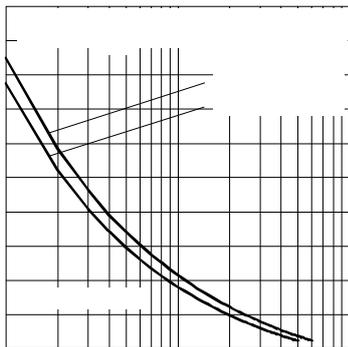


Fig. 7 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

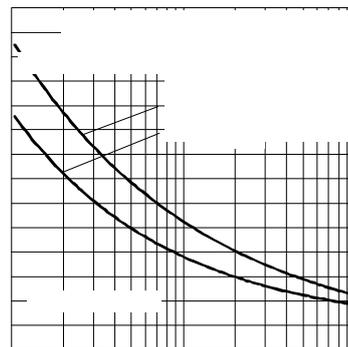


Fig. 8 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

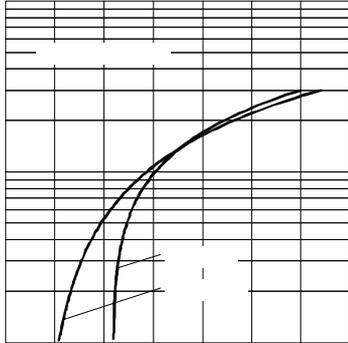


Fig. 9 - On-state Voltage Drop Characteristics

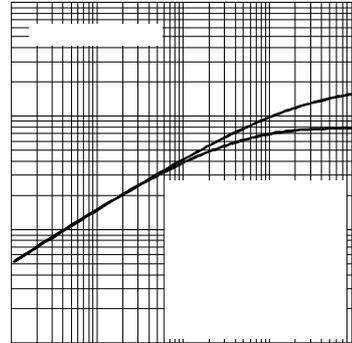


Fig. 10 - Thermal Impedance $Z_{th(j-hs)}$ Characteristics

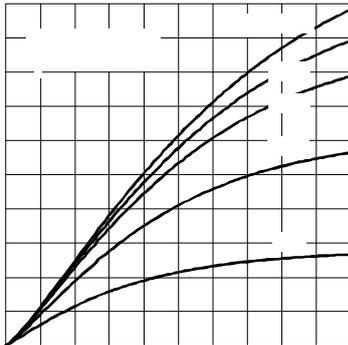


Fig. 11 - Reverse Recovered Charge Characteristics

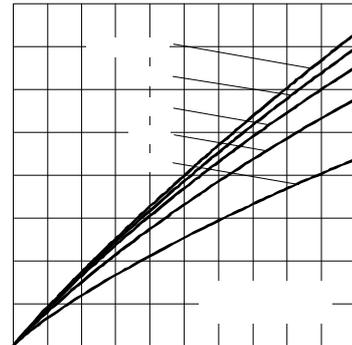


Fig. 12 - Reverse Recovery Current Characteristics

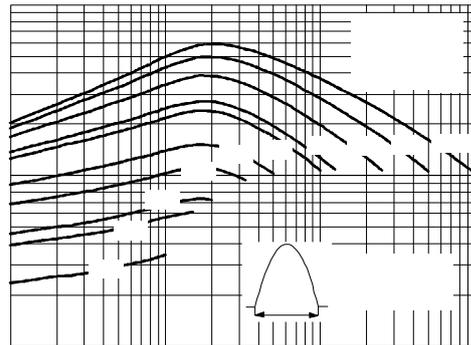
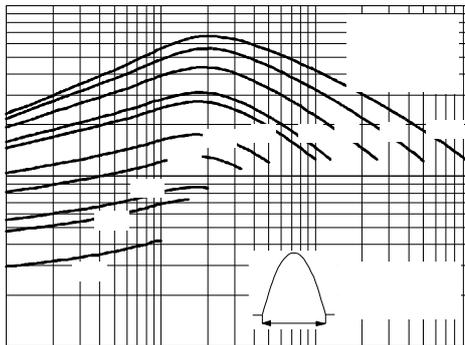


Fig. 13 - Frequency Characteristics

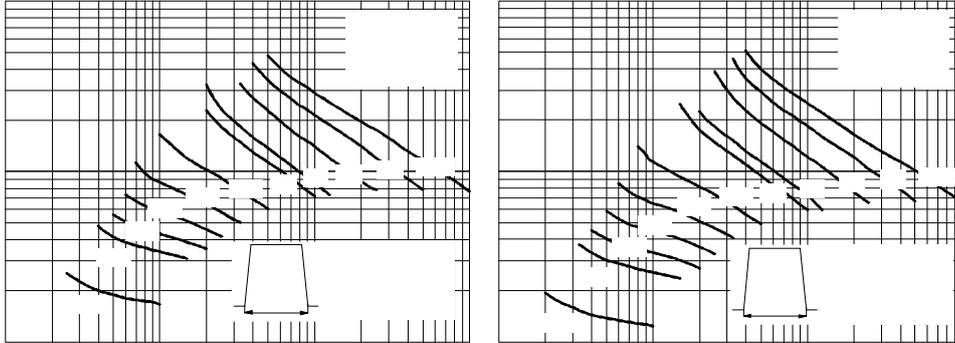


Fig. 14 - Frequency Characteristics

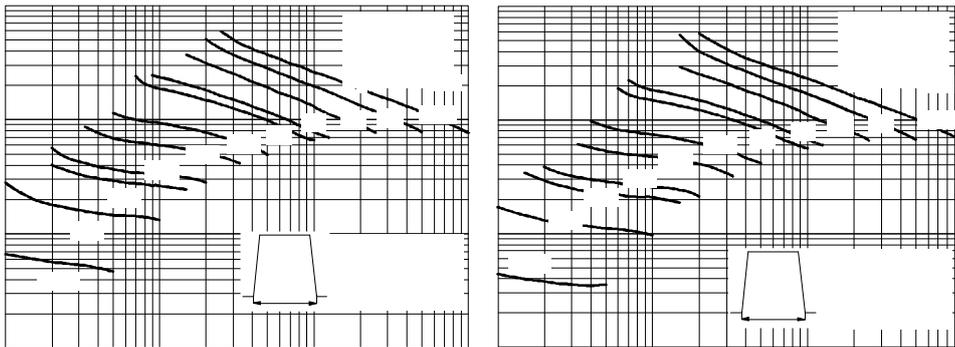


Fig. 15 - Frequency Characteristics

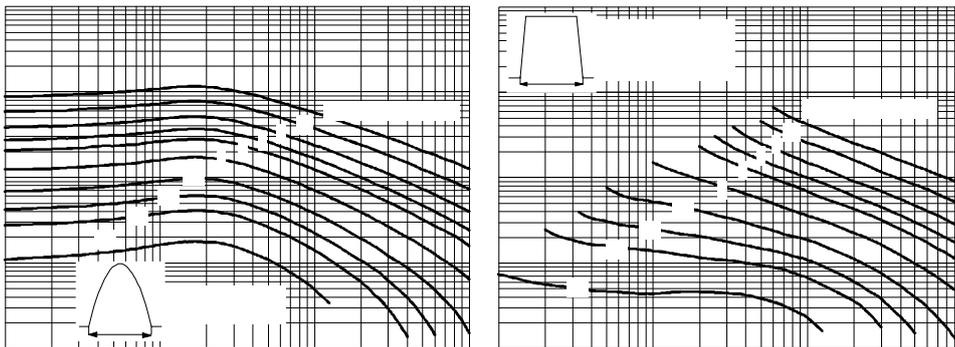


Fig. 16 - Maximum On-state Energy Power Loss Characteristics

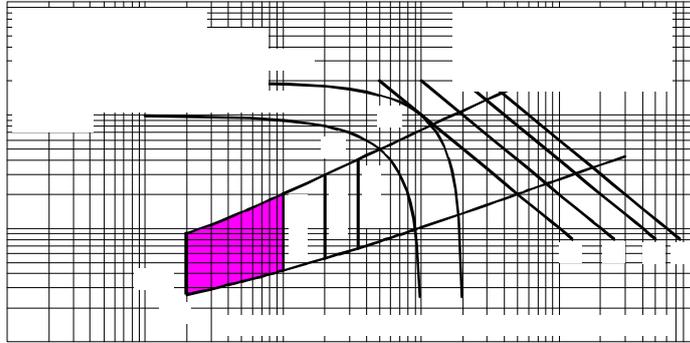


Fig. 17 - Gate Characteristics

On-state Conduction

| Parameter | ST173C..C | Units | Conditions |
|---|-----------|------------|---|
| V_{TM} Max. peak on-state voltage | 2.07 | V | $I_{TM} = 600A$, $T_J = T_J \text{ max}$, $t_p = 10\text{ms}$ sine wave pulse |
| $V_{T(TO)1}$ Low level value of threshold voltage | 1.55 | | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J \text{ max}$. |
| $V_{T(TO)2}$ High level value of threshold voltage | 1.61 | | $(I > \pi \times I_{T(AV)})$, $T_J = T_J \text{ max}$. |
| r_{t1} Low level value of forward slope resistance | 0.87 | m Ω | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J \text{ max}$. |
| r_{t2} High level value of forward slope resistance | 0.77 | | $(I > \pi \times I_{T(AV)})$, $T_J = T_J \text{ max}$. |
| I_H Maximum holding current | 600 | mA | $T_J = 25^\circ\text{C}$, $I_T > 30A$ |
| I_L Typical latching current | 1000 | | $T_J = 25^\circ\text{C}$, $V_A = 12V$, $R_a = 6\Omega$, $I_G = 1A$ |

Switching

| Parameter | ST173C..C | Units | Conditions |
|---|------------------|------------------|--|
| di/dt Max. non-repetitive rate of rise of turned-on current | 1000 | A/ μs | $T_J = T_J \text{ max}$, $V_{DRM} = \text{rated } V_{DRM}$ $I_{TM} = 2 \times \text{di/dt}$ |
| t_d Typical delay time | 1.1 | μs | $T_J = 25^\circ\text{C}$, $V_{DM} = \text{rated } V_{DRM}$, $I_{TM} = 50A \text{ DC}$, $t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5 Ω source |
| t_q Max. turn-off time | Min 15 Max 30 | | $T_J = T_J \text{ max}$, $I_{TM} = 300A$, commutating di/dt = 20A/ μs $V_R = 50V$, $t_p = 500\mu\text{s}$, dv/dt: see table in device code |

Blocking

| Parameter | ST173C..C | Units | Conditions |
|--|-----------|------------------|---|
| dv/dt Maximum critical rate of rise of off-state voltage | 500 | V/ μs | $T_J = T_J \text{ max}$. linear to 80% V_{DRM} , higher value available on request |
| I_{RRM} I_{DRM} Max. peak reverse and off-state leakage current | 40 | mA | $T_J = T_J \text{ max}$, rated V_{DRM}/V_{RRM} applied |

Triggering

| Parameter | ST173C..C | Units | Conditions |
|---|-----------|-------|--|
| P_{GM} Maximum peak gate power | 60 | W | $T_J = T_J \text{ max}$, $f = 50\text{Hz}$, $d\% = 50$ |
| $P_{G(AV)}$ Maximum average gate power | 10 | | |
| I_{GM} Max. peak positive gate current | 10 | A | $T_J = T_J \text{ max}$, $t_p \leq 5\text{ms}$ |
| $+V_{GM}$ Maximum peak positive gate voltage | 20 | V | $T_J = T_J \text{ max}$, $t_p \leq 5\text{ms}$ |
| $-V_{GM}$ Maximum peak negative gate voltage | 5 | | |
| I_{GT} Max. DC gate current required to trigger | 200 | mA | $T_J = 25^\circ\text{C}$, $V_A = 12V$, $R_a = 6\Omega$ |
| V_{GT} Max. DC gate voltage required to trigger | 3 | | |
| I_{GD} Max. DC gate current not to trigger | 20 | mA | $T_J = T_J \text{ max}$, rated V_{DRM} applied |
| V_{GD} Max. DC gate voltage not to trigger | 0.25 | | |

ST173C..C Series

Thermal and Mechanical Specification

| Parameter | ST173C..C | Units | Conditions |
|---|--------------------|-----------|--|
| T _J Max. operating temperature range | -40 to 125 | °C | |
| T _{stg} Max. storage temperature range | -40 to 150 | | |
| R _{thJ-hs} Max. thermal resistance, junction to heatsink | 0.17 0.08 | K/W | DC operation single side cooled DC operation double side cooled |
| R _{thC-hs} Max. thermal resistance, case to heatsink | 0.033 0.017 | K/W | DC operation single side cooled DC operation double side cooled |
| F Mounting force, ± 10% | 4900 (500) | N (Kg) | |
| wt Approximate weight | 50 | g | |
| Case style | TO - 200AB (A-PUK) | | See Outline Table |

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

| Conduction angle | Sinusoidal conduction | | Rectangular conduction | | Units | Conditions |
|------------------|-----------------------|-------------|------------------------|-------------|-------|--------------------------------------|
| | Single Side | Double Side | Single Side | Double Side | | |
| 180° | 0.015 | 0.016 | 0.011 | 0.011 | K/W | T _J = T _J max. |
| 120° | 0.018 | 0.019 | 0.019 | 0.019 | | |
| 90° | 0.024 | 0.024 | 0.026 | 0.026 | | |
| 60° | 0.035 | 0.035 | 0.036 | 0.037 | | |
| 30° | 0.060 | 0.060 | 0.060 | 0.061 | | |

Ordering Information Table

| Device Code | | | | | | | | | |
|-------------|--|----------|----------|-----------|----------|----------|----------|----------|---|
| ST | 17 | 3 | C | 12 | C | H | K | 1 | |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | ⑨ | ⑩ |
| 1 | - Thyristor | | | | | | | | |
| 2 | - Essential part number | | | | | | | | |
| 3 | - 3 = Fast turn off | | | | | | | | |
| 4 | - C = Ceramic Puk | | | | | | | | |
| 5 | - Voltage code: Code x 100 = V _{RRM} (See Voltage Rating Table) | | | | | | | | |
| 6 | - C = Puk Case TO-200AB (A-PUK) | | | | | | | | |
| 7 | - Reapplied dv/dt code (for t _q test condition) | | | | | | | | |
| 8 | - t _q code | | | | | | | | |
| 9 | - 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads) | | | | | | | | |
| | 1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads) | | | | | | | | |
| | 2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads) | | | | | | | | |
| | 3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads) | | | | | | | | |
| 10 | - Critical dv/dt: | | | | | | | | |
| | None = 500V/μsec (Standard value) | | | | | | | | |
| | L = 1000V/μsec (Special selection) | | | | | | | | |

| dv/dt - t _q combinations available | | | | | |
|---|----|----|-----|-------------|-----|
| dv/dt (V/μs) | 20 | 50 | 100 | 200 | 400 |
| 15 | CL | -- | -- | -- | -- |
| 18 | CP | DP | EP | FP * | -- |
| 20 | CK | DK | EK | FK * | HK |
| 25 | CJ | DJ | EJ | FJ | HJ |
| 30 | -- | DH | EH | FH | HH |

*Standard part number.
All other types available only on request.

Outline Table

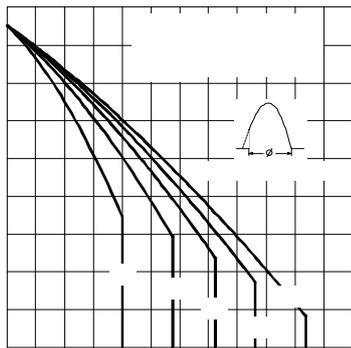
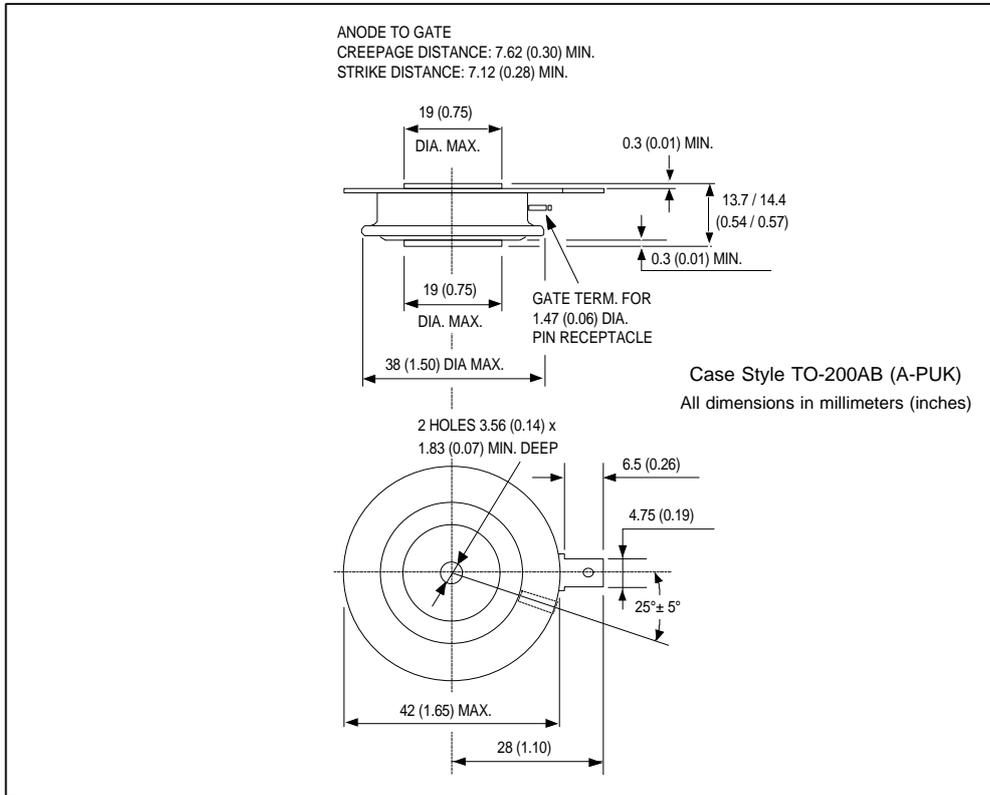


Fig. 1 - Current Ratings Characteristics

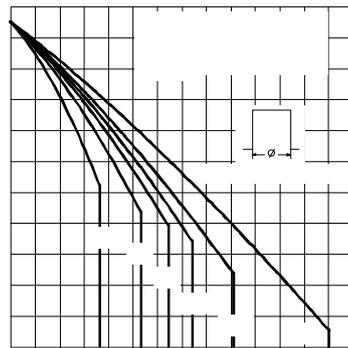


Fig. 2 - Current Ratings Characteristics